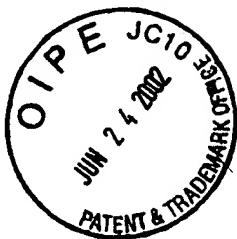


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June 18, 2002

ATLANTA	BOSTON	CHICAGO	HOUSTON	LOS ANGELES	NEW YORK	SACRAMENTO	SAN FRANCISCO	WASHINGTON, D.C.	BRUSSELS
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Re: Snap-on Technologies, Inc.  
Matter No. 452691  
Patent Application for: NON-CONDENSABLE  
PURGE TECHNIQUE USING REFRIGERANT  
TEMPERATURE OFFSET  
Serial No. 09/887,277

Sir:

Transmitted for filing herewith are a Letter to the Drawing Review Branch and copies of 2 sheets of formal patent drawings (figures 1-3B).

It is believed that no fee is required. However, if there is a fee, you are authorized to charge same to Deposit Account No. 19-1351.

Sincerely yours,

Harold V. Stotland

HVS:cw

**CERTIFICATE OF MAILING**

I hereby certify that, on 6/18/02, this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, BOX ISSUE FEE, Washington, D.C. 20231.

Carolyn Wilson  
Carolyn Wilson

04/ 02



In re Application of: Dean P. Pfefferle et al.

Confirmation No. 6277

Serial No.: 09/887,277

**Examiner: Mark S. Shulman**

Filing Date: June 22, 2001

Group Art Unit: 3744

For: NON-CONDENSABLE PURGE  
TECHNIQUE USING REFRIGERANT  
TEMPERATURE OFFSET



27717

PATENT TRADEMARK OFFICE

Date: June 18, 2002

Commissioner for Patents  
BOX ISSUE FEE  
Washington, D.C. 20231

**LETTER TO DRAWING REVIEW BRANCH**

Sir:

Responsive to the examiner's request in paper no. 5, enclosed are copies of the two sheets of formal patent drawings (figures 1-3B) for the above-identified application.

Respectfully submitted,

Seyfarth Shaw  
Attorneys for Assignee  
55 E. Monroe Street - 42nd Floor  
Chicago, Illinois 60603-5803  
312-346-8000

By: